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# **<u>MOSFET</u> – N-Channel,** SUPERFET<sup>®</sup> II, Easy-Drive

600 V, 15 A, 260 m $\Omega$ 

# FCP260N60E, FCPF260N60E

#### Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SUPERFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SUPERFET II MOSFET series.

#### Features

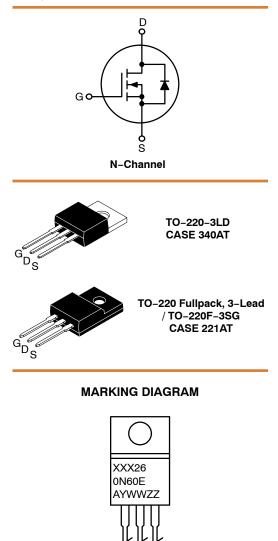
- 650 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 220 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 48 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 129 pF)
- 100% Avalanche Tested
- An Integrated Gate Resistor
- RoHS Compliant

#### Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
600 V	260 mΩ @ 10 V	15 A*	

\*Drain current limited by maximum junction temperature.



XXX260N60E	= Device Code (XXX = FCP, FCPF)
А	= Assembly Location
YWW	= Date Code (Year & Week)
ZZ	= Assembly Lot

#### **ORDERING INFORMATION**

Device	Package	Shipping
FCP260N60E	TO-220	800 Units / Tube
FCPF260N60E	TO-220F	1000 Units / Tube

Symbol		Parameter	FCP260N60E	FCPF260N60E	Unit
V <sub>DSS</sub>	Drain to Source Voltage		6	600	
V <sub>GSS</sub>	Gate to Source Voltage –DC		±	V	
		–AC (f > 1 Hz)	±30		
ID	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	15	15*	Α
		– Continuous (T <sub>C</sub> = 100°C)	9.5	9.5*	
I <sub>DM</sub>	Drain Current	– Pulsed (Note 1)	45	45*	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		292.5		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		3.0		Α
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		1.56		mJ
dv/dt	MOSFET dv/dt		100		V/ns
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	156	36	W
		-Derate above 25°C	1.25	0.29	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range -55 to +150		o +150	°C	
ΤL	Maximum Lead Temperat 1/8" from Case for 5 Seco		300		°C

#### MOSFET MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 3 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \leq 7.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq \text{BV}_{DSS}$ , starting  $T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

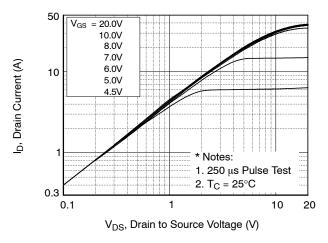
Symbol	Parameter	FCP260N60E	FCPF260N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.8	3.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

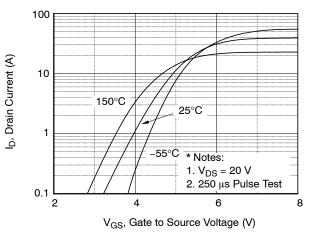
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 10 mA, T <sub>J</sub> = 25°C	600	-	-	V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 10 mA, T <sub>J</sub> = 150°C	650	-	-	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$ , referenced to 25°C	-	0.67	-	V/°C
BV <sub>DS</sub>	Drain to Source Avalanche Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 15 A	-	700	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	-	-	1	μA
		$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	2.6	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARA	CTERISTICS					•
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	2.5	_	3.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.5 A	-	0.22	0.26	Ω
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 7.5 A	-	15.5	-	S
DYNAMIC (	CHARACTERISTICS			•		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	1880	2500	pF
C <sub>oss</sub>	Output Capacitance		-	1330	1770	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	85	130	pF
Coss	Output Capacitance	$V_{DS}$ = 380 V, $V_{GS}$ = 0 V, f = 1 MHz	-	32	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 \text{ V} \text{ to } 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	129	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	48	62	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	-	7.4	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	17	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	5.8	-	Ω
SWITCHING	G CHARACTERISTICS	•				
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	20	50	ns
tr	Turn-On Rise Time	R <sub>G</sub> = 4.7 Ω (Note 4)	-	11	32	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	89	188	ns
t <sub>f</sub>	Turn–Off Fall Time		-	13	36	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS					•
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current			-	15	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	45	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 7.5 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS}$ = 0 V, I <sub>SD</sub> = 7.5 A, dI <sub>F</sub> /dt = 100 A/µs	-	270	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1	-	3.6	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

### **TYPICAL PERFORMANCE CHARACTERISTICS**









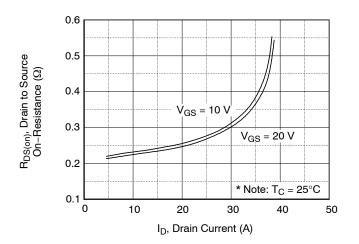


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

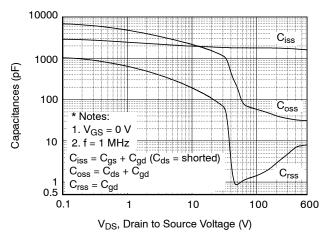


Figure 5. Capacitance Characteristics

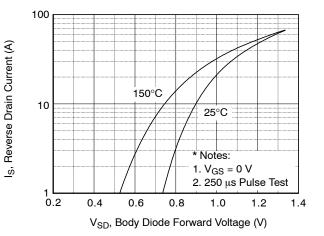


Figure 4. Body Diode Forward Voltage Variation vs. Source Current And Temperature

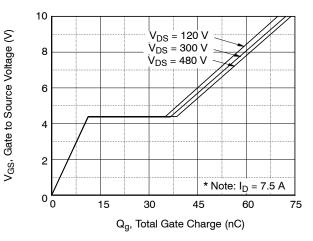
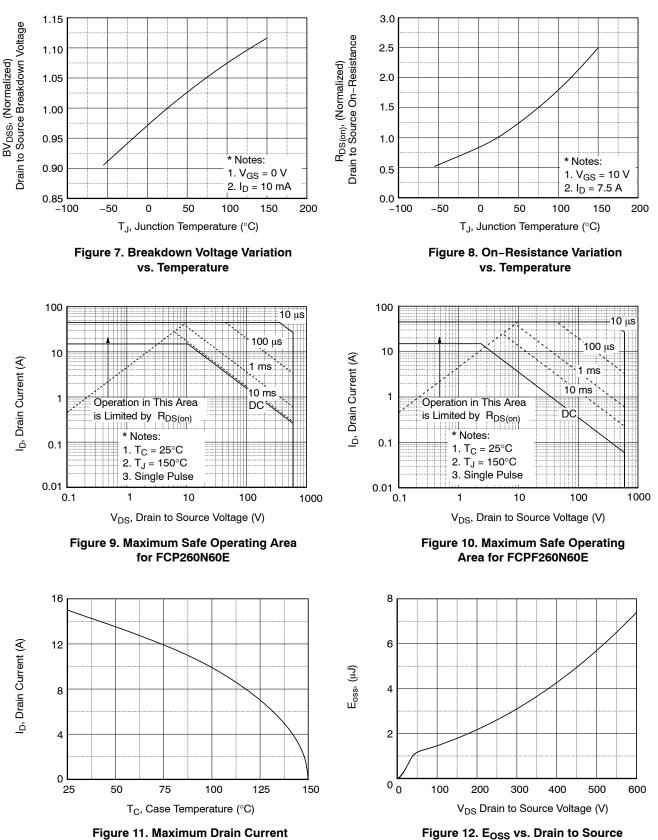


Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



vs. Case Temperature

Voltage

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

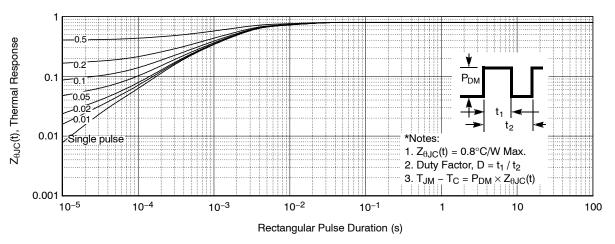


Figure 13. Transient Thermal Response Curve for FCP260N60E

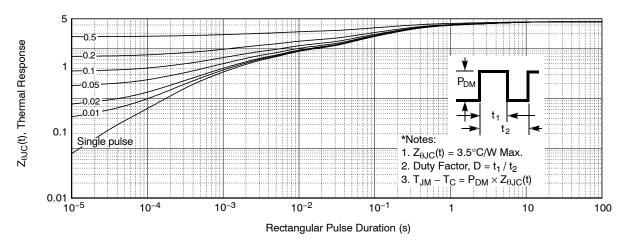
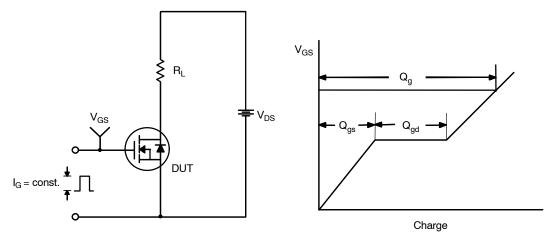


Figure 14. Transient Thermal Response Curve for FCPF260N60E





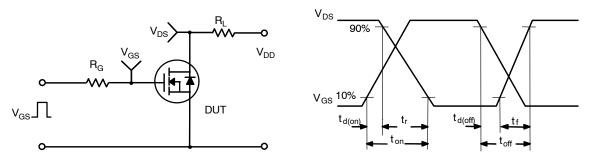


Figure 16. Resistive Switching Test Circuit & Waveforms

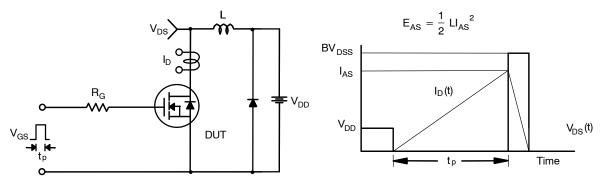


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms

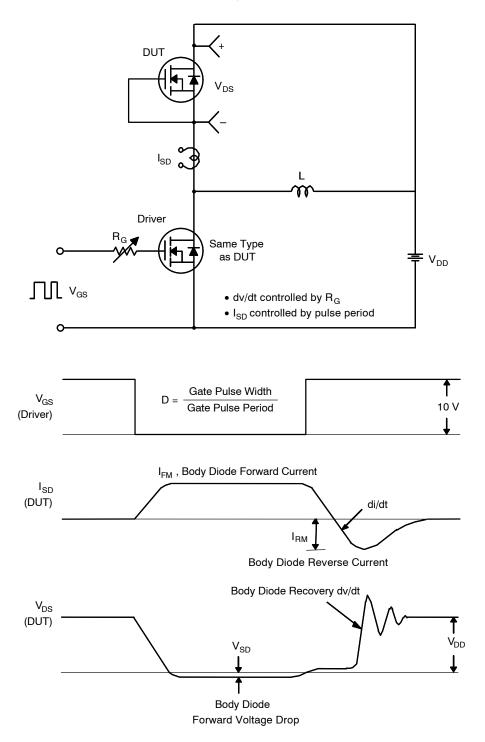
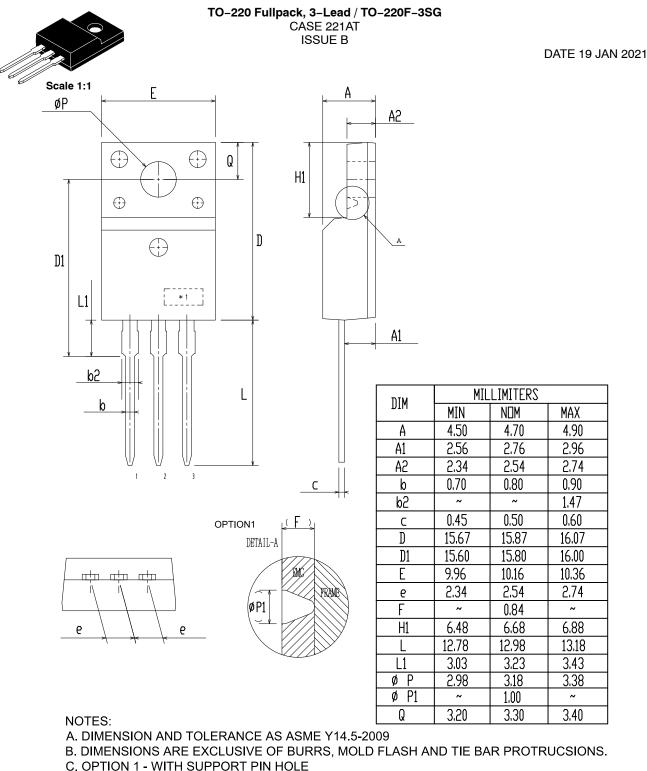


Figure 18. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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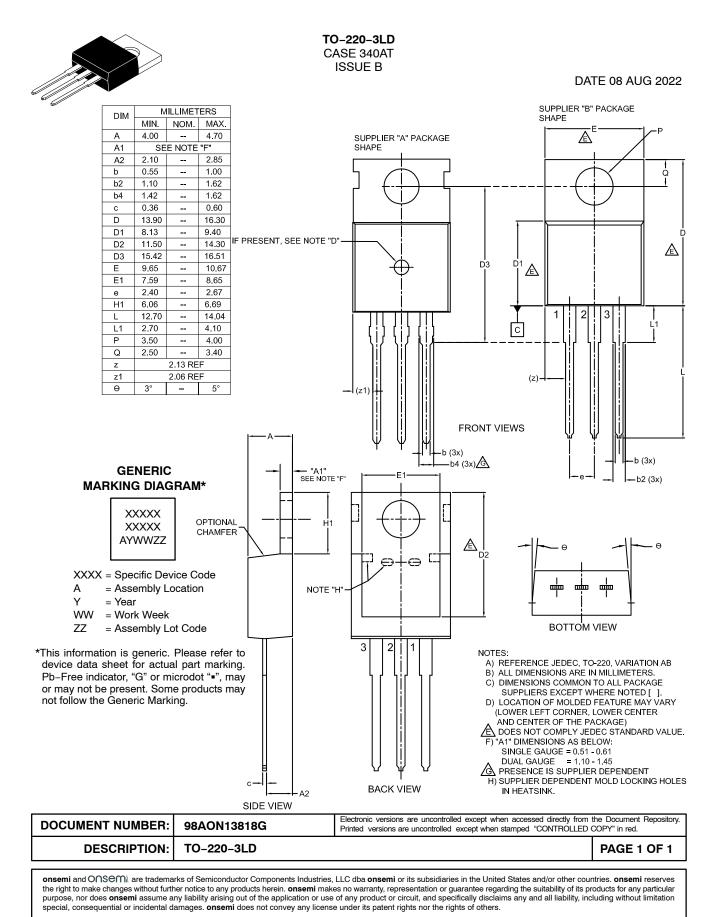


OPTION 2 - NO SUPPORT PIN HOLE

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